MEMORANDUM OF UNDERSTANDING

between

THE INSTITUTION OF ENGINEERS, MALAYSIA (IEM)

Bangunan Ingenieur Lots 60/62, Jalan 52/4, Peti surat 223, Jalan Sultan 46720 Petaling Jaya, Selangor Darul Ehsan Malaysia

and

THE INSTITUTE OF ELECTRICAL ENGINEERS OF JAPAN (IEEJ)

Homat Horizon Building 8F 6-2 Go-bancho, Chiyoda-ku Tokyo 102-0076, JAPAN By this agreement The Institution of Engineers, Malaysia (IEM) and The Institute of Electrical Engineers of Japan (IEEJ), establish a cooperative relationship in their areas of interest devoted to the promotion of the art, science and practice of engineering.

No joint action will be allowed that would violate the laws and regulations of either country. Each organisation will respect the copyright policy of the other organisation and agree that intellectual property will not be republished without prior written permission from the originating organisation.

This agreement is based on a concept of independent and bilateral activities of each organisation. To encourage the exchange and dissemination of technical information, and to promote understanding and co-operation between the members of The Institution of Engineers, Malaysia (IEM) and the Institute of Electrical Engineers of Japan (IEEJ), these organisations have entered into an agreement on the following matters:

1. Visiting Members

When members of the IEM visit Japan, or members of the IEEJ visit Malaysia, for a period not exceeding one year, they shall be given the opportunity to avail themselves of the facilities, services and programmes of the other institution under the same conditions as those granted to members of the host institution.

2. Joint Activities

The IEM and the IEEJ may, subject to agreement on specific items, enter into joint projects, events, and products such as conferences, forums, publications, history, standards, educational materials, etc. Joint activities devoted to preserving and sustaining the environment, teaching mathematics and science to children, improving technology awareness among the general public, and improving the image of engineers and the profession will also be explored. The IEM and the IEEJ or their technical societies are encouraged to develop joint activities, based on individual agreements, including co-sponsorship on conferences, joint publications, exchange of technical papers, translations, etc.

3. Information Exchange

By mutual agreement, certain publications may be exchanged between the IEM and the IEEJ.

Plans and schedules for international conferences and major events will be exchanged between the IEM and the IEEJ.

To the extent practical, consultation will take place when it is proposed to conduct a major conference or event in Malaysia by the IEEJ or in Japan by the IEM.

4. Publications

Members of one organisation may receive certain publications of the other organisation at reduced rates.

Reduced rates for the publications of individual technical societies may be established by supplemental agreements.

5. Amendments, Supplement and Termination

Amendments to the agreement may be proposed at any time, but will not be valid until approved by both the IEM and the IEEJ.

Other cooperative agreements, which may be made in the future shall be documented in a supplement to this agreement. These may include agreements, which encourage electrical engineers of each institution to become members of both institutions.

The term of this agreement shall be automatically extended unless any party of both institutions requests the termination of this agreement in writing.

Approved by the Councils of

The Institution of Engineers, Malaysia

The Institute of Electrical Engineers of Japan

Signed on 29 January 2002 at Bangunan Ingenieur, Malaysia.

The Institution of Engineers, Malaysia (IEM) The Institute of Electrical Engineers of Japan (IEEJ)

President

Ir. Dr. Gue See Sew

Date: 29 Jan 2002

President

Professor Fumio Harashima

Two Harrishi

Date: Jan. 29, 2002

Honorary Secretary

Ir. Lee Weng Onn

Date: 294 Jay. 2002

Executive Managing Director

4. Murank

Mr. Yasuo Muraoka

Date: January 29, 2009